

## 9-Line Low Capacitance SCSI Active Terminator

#### **FEATURES**

- Complies with SCSI, SCSI-2 and SPI-2 Standards
- 3pF Channel Capacitance during Disconnect
- 100μA Supply Current in Disconnect Mode
- Meets SCSI Hot Plugging Capability
- –400mA Sourcing Current for Termination
- +400mA Sinking Current for Active Negation
- Logic Command Disconnects all Termination Lines
- Trimmed Termination Current to 5%
- Trimmed Impedance to 5%
- Current Limit and Thermal Shutdown Protection

#### **DESCRIPTION**

The UC5613 provides 9 lines of active termination for a SCSI (Small Computer Systems Interface) parallel bus. The SCSI standard recommends active termination at both ends of the cable segment.

The UC5613 provides a disconnect feature which, when opened or driven high, disconnects all terminating resistors and disables the regulator greatly reducing standby power. The output channels remain high impedance even without Termpwr applied. A low channel capacitance of 3pF allows units at interim points of the bus to have little or no effect on the signal integrity.

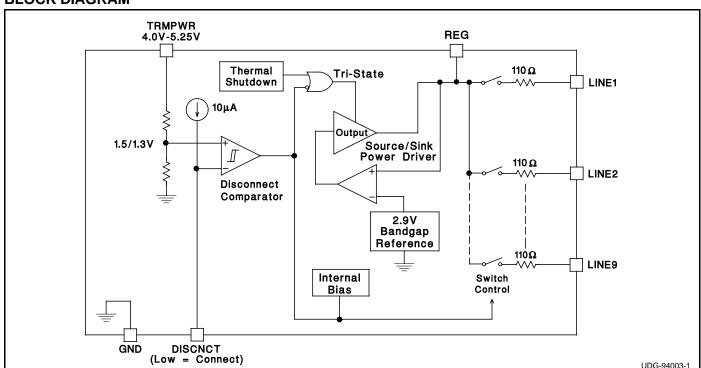
The UC5613 is pin-for-pin compatible with its predecessor, the UC5603 - 9 line Active Terminator. The only functional difference between the UC5613 and UC5603 is the absence of the negative clamps. Parametrically, the UC5613 has a 5% tolerance on impedance and current compared to a 3% tolerance on the UC5603. Custom power packages are utilized to allow normal operation at full power (1.2 watts).

Internal circuit trimming is utilized, first to trim the impedance to a 5% tolerance; then, the output current is trimmed to a 5% tolerance. The output current trim is set as close as possible to the maximum value of the SCSI specification which maximizes the noise margin for fast SCSI operation.

Other features include thermal shutdown and current limit.

This device is offered in low thermal resistance versions of the industry standard 16 pin narrow body SOIC, 16 pin ZIP (zig-zag in line package), and 24 pin TSSOP.

#### **BLOCK DIAGRAM**



#### **ABSOLUTE MAXIMUM RATINGS**

Termpwr Voltage	. +7V
Signal Line Voltage	o +7V
Regulator Output Current	0.5A
Storage Temperature	150°C
Operating Temperature –55°C to +1	150°C
Lead Temperature (Soldering, 10 Sec.)	300°C

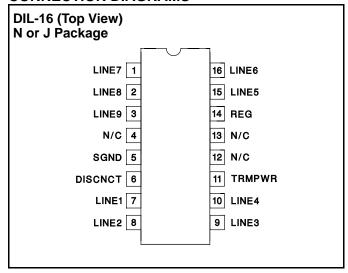
Unless otherwise specified all voltages are with respect to Ground. Currents are positive into, negative out of the specified terminal.

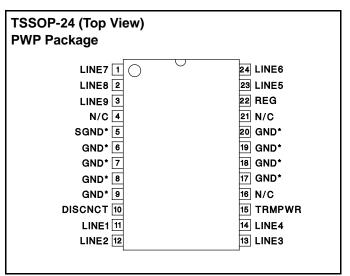
Consult Packaging Section of Unitrode Integrated Circuits databook for thermal limitations and considerations of packages.

#### RECOMMENDED OPERATING CONDITIONS

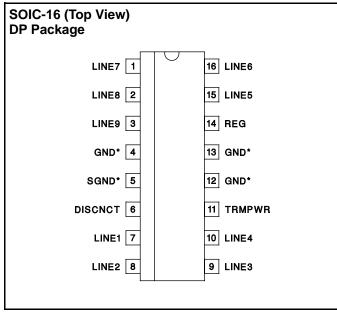
Termpwr Voltage	3.8V to 5.25V
Signal Line Voltage	0V to +5V
Disconnect Input Voltage	OV to Termpwr

#### **CONNECTION DIAGRAMS**



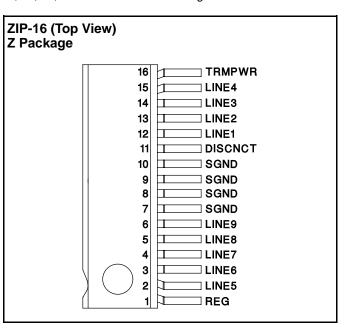


\* PWP package pin 5 serves as signal ground; pins 6, 7, 8, 9, 17, 18, 19, and 20 serve as heatsink/ground.



<sup>\*</sup> DP package pin 5 serves as signal ground; pins 4, 12, 13 serve as heatsink/ground.

Note: Drawings are not to scale.



# **ELECTRICAL CHARACTERISTICS** Unless otherwise stated, these specifications apply for TA = 0°C to 70°C. TRMPWR = 4.75V, DISCNCT = 0V. TA = TJ.

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNITS
Supply Current Section							
Termpwr Supply Current	All termination lines = Open				17	23	mA
	All termination lines = 0.5V				200	225	mA
Power Down Mode	DISCNCT = Open				100	150	μΑ
<b>Output Section (Terminator Lines</b>	)						
Terminator Impedance	$\Delta$ ILINE = -5mA to -15mA			104.5	110	115.5	Ohms
Output High Voltage	TRMPWR = 4V (Note 1)			2.7	2.9		V
Max Output Current	VLINE = $0.5V$ $TJ = 25^{\circ}C$ $0^{\circ}C < TJ < 70^{\circ}C$		-20.3	-21.5	-22.4	mA	
			-19.8	-21.5	-22.4	mA	
Max Output Current	VLINE = 0.5V, TR	VLINE = $0.5V$ , TRMPWR = $4V$ (Note 1) $T_J = 2$		-19.5	-21.5	-22.4	mA
			$0^{\circ}\text{C} < \text{T}_{\text{J}} < 70^{\circ}\text{C}$	-19.0	-21.5	-22.4	mA
	VLINE = 0.2V, TR	MPWR = 4V to 5.25V	$0^{\circ}\text{C} < \text{T}_{\text{J}} < 70^{\circ}\text{C}$	-21.6	-24.0	-25.4	mA
Output Leakage	DISCNCT = 4V	TRMPWR = 0V to 5.25V REG = 0V	VLINE = 0 to 4V		10	400	nA
DISCINC	D1001101 = 4V		VLINE = 5.25V			100	μΑ
		TRMPWR = $0V$ to $5.25V$ ,	REG = Open		10	400	nA
		VLINE = 0V to 5.25V					
Output Capacitance DISCNCT = Open, DP Package (Note 2)					3	4.5	pF
Regulator Section	1			•	•	•	
Regulator Output Voltage	ulator Output Voltage				2.9	3	V
Regulator Output Voltage	All Termination Lines = 5V			2.8	2.9	3	V
Line Regulation	TRMPWR = 4V to 6V  IREG = +100mA to -100mA  All Termination Lines = 0.5V				10	20	mV
Load Regulation					20	50	mV
Drop Out Voltage					0.7	1	V
Short Circuit Current	VREG = 0V VREG = 3.5V		-200	-400	-600	mA	
Sinking Current Capability			200	400	600	mA	
Thermal Shutdown				170		°C	
Thermal Shutdown Hysteresis					10		°C
Disconnect Section							
Disconnect Threshold				1.3	1.5	1.7	V
Threshold Hysteresis				100	160	250	mV
Input Current	DISCNCT = 0V				10	15	μΑ

Note 1: Measuring each termination line while other 8 are low (0.5V).

Note 2: Guaranteed by design. Not 100% tested in production.

#### **APPLICATION INFORMATION**

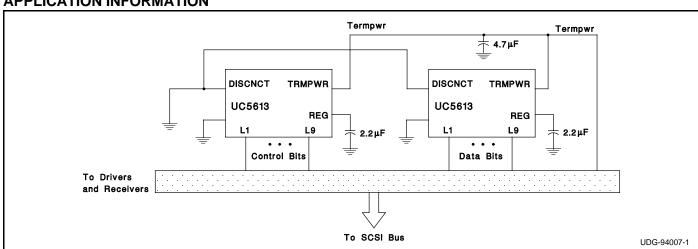


Figure 1: Typical SCSI Bus Configurations Utilizing 2 UC5613 Devices

### **APPLICATION INFORMATION (cont.)**

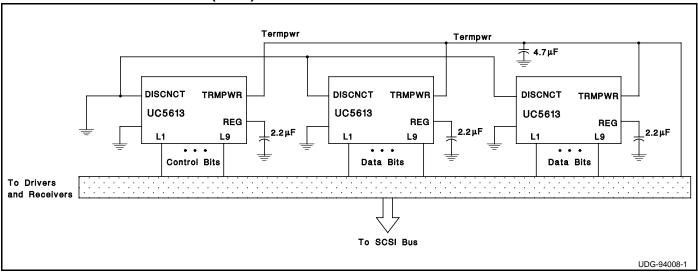


Figure 2: Typical Wide SCSI Bus Configurations Utilizing 3 UC5613 Devices.

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